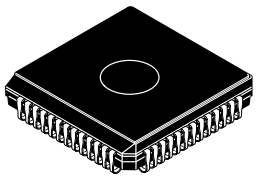
Product Preview

155Mb/s / 622Mb/s Transmitter (Multiplexer) with Clock Generation

MC10SX1405

TRANSMITTER (MULTIPLEXER) WITH CLOCK GENERATION



FN SUFFIX
CLCC PACKAGE
CASE 778B-01

The MC10SX1405 transmitter (Tx) chip is an integrated serialization SONET OC–3 (155.52Mb/s) and OC–12 (622.08 Mb/s) interface device. It generates the line rate clock and performs parallel–to–serial conversion in conformance with SONET/SDH transmission standards. High performance and low power is achieved with MOSAIC VTM, Motorola's most advanced high–performance silicon Bipolar process. A companion de–serialization (Rx) chip, the SX1401, is also available.

- Selectable eight or four bit parallel interface
- Performs parallel–to–serial conversion of four 38.88 Mbit/s or eight 19.44 Mbit/s inputs to a 155.52 Mbit/s OC3 serial data output
- Performs parallel–to–serial conversion of eight 77.76 Mbit/s inputs to a 622.08 Mbit/s OC12 serial data output
- Integrated PLL and VCO to generate the line–rate clock from a sub–rate reference clock
- Multiple configurations for parallel interface timing provide system design versatility
- Provides PLL Frequency Control Monitor and Out–of–Lock Indicator
- Provides parity verification of the OC3/OC12 serial output stream
- Single supply operation (+5V)

APPLICATIONS

- SONET/SDH–based transmission systems, modules, test equipment
- ATM using SONET
- Add drop multiplexers
- Other (non–SONET) data rate transmission systems

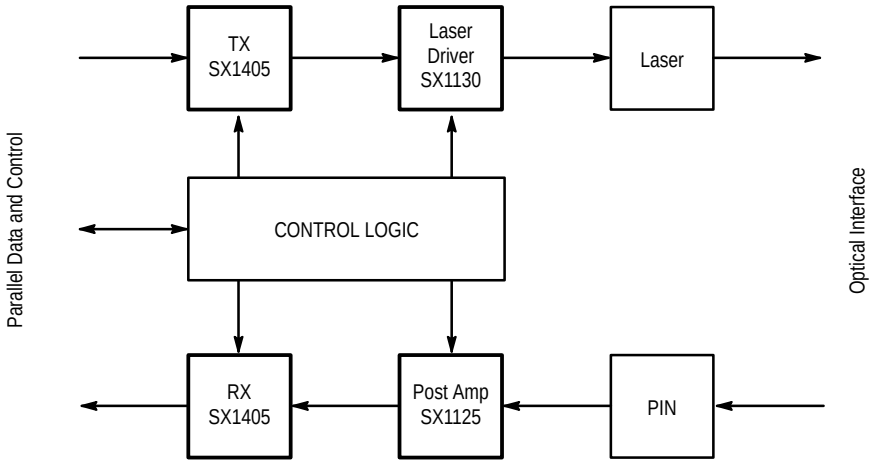


Figure 1. Typical OC3/OC12 Electro–Optical Interface

This document contains information on a new product. Specifications and information herein are subject to change without notice.

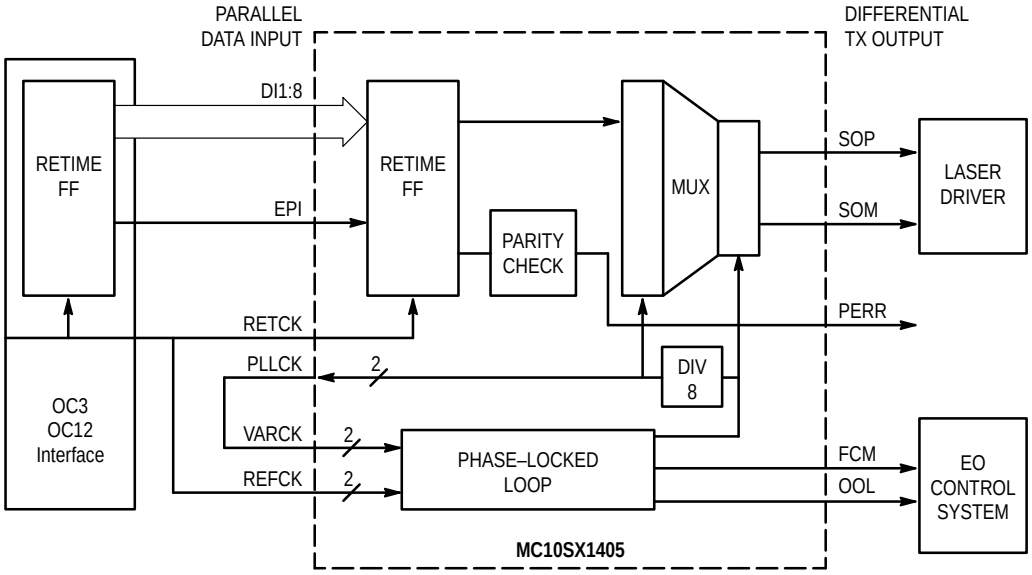


Figure 2. MC10SX1405 Simplified Block Diagram

SX1405 Theory of Operation

Operation of the SX1405 is straightforward. Parallel data is input to the device. Serial–to–parallel conversion is performed. Then the serial data is output at the selected line rate clock. The 78 MByte/s or 19 MByte/s parallel data is converted into a bit–serial 622 Mbit/s or 155 Mbit/s data stream.

The on–chip PLL generates the 622 MHz or 155 MHz line rate clock from a subrate clock. For testing and applications which provide an external high–frequency bit clock, the internal clock generation PLL may be bypassed.

SX1405 Block Diagram Functional Description

Phase Locked Loop

The on–chip Phase Locked Loop (PLL) synthesizes the internal bit rate clock from the 19.44 / 38.66 / 77.78 MHz input reference clock. The PLL consists of a phase / frequency detector, loop filter, and Voltage Controlled Oscillator (VCO) nominally operating at 1.2 GHz. Dividers provide the internal clocks and a sub–rate clock output PLLCKP/PLLCKM (differential PECL) for phase comparison.

REFCK/REFCKM is the differential input PLL reference clock. The feedback, to close the loop of the PLL, is VARCK/VARCKM, the differential input variable clock. Both the REFCK and VARCK inputs can be driven by TTL levels if the “minus” input (REFCKM and VARCKM) are left open.

An Out Of Lock indicator (OOL) is driven HIGH if the PLL is not frequency locked with the input reference clock.

Parallel to Serial Conversion

In OC3 mode, converts a 4–bit (Nibble) 38.88 Mb/s or 8–bit (Byte) 19.44 Mb/s input to a differential 155.52 Mb/s serial data output. In OC12 mode, converts an 8–bit 77.76 Mb/s input to a differential 622.08 Mb/s serial data output. The input data is loaded into the Retime FF’s by the Retiming Clock RETCK. Then the data is loaded into a shift register by PLLCK. The data shifted out is ordered MSB (DI1) first and LSB (DI8 or DI4) last.

Parity Check

The parity check provides a means of verifying the integrity of the parallel to serial converter with minimal overhead. The parity of the serial output data stream is compared to the value of the Even Parity Input (EPI). If a parity error is deteced, the Parity Error (PERR) output is set HIGH. The PERR pin has an Open Collector TTL Output and must be given a falling edge to reset the parity error detector.

SX1405 Control Signals

Reset (RSTN) – Used for testing and verification, the TTL outputs are set to Tri–State and all divider flip–flops and the parity generator are reset when RSTN = LOW. This also sets PERR HIGH and PERR must be given a falling edge to reset the parity error detector for normal operation. An internal pull–up is provided on RSTN allowing the device to operate normally if RSTN is not used.

Low Speed Select (LSS) – Selects data rate. LOW = OC–12 (622.08 Mb/s), HIGH = OC–3 (155.52 Mb/s). An

internal pull–up is provided on LSS allowing the device to operate in OC–3 mode if LSS is not used.

Nibble / Byte Select (NBB) – In OC–3 mode, selects between 4–bit (Nibble) and 8–bit (Byte) parallel data input format. LOW = Byte, HIGH = Nibble. An internal pull–up is provided on NBB allowing the device to operate in Nibble mode if NBB is not used.

External Clock Select (ECSN) – Allows external high–frequency bit clock to be applied and bypasses the internal clock generation circuit. LOW = External bit clock. An internal pull–up is provided on ECSN allowing the device to operate normally if ECSN is not used.

VCO Frequency Control Monitor (FCM) – Single ended reference voltage output generated from the VCO control voltage. Typically 1.25V and varying from 0.25V to 2.25V.

Out of Lock Indicator (OOL) – Is set HIGH if the PLL is not frequency–locked to the input reference clock.

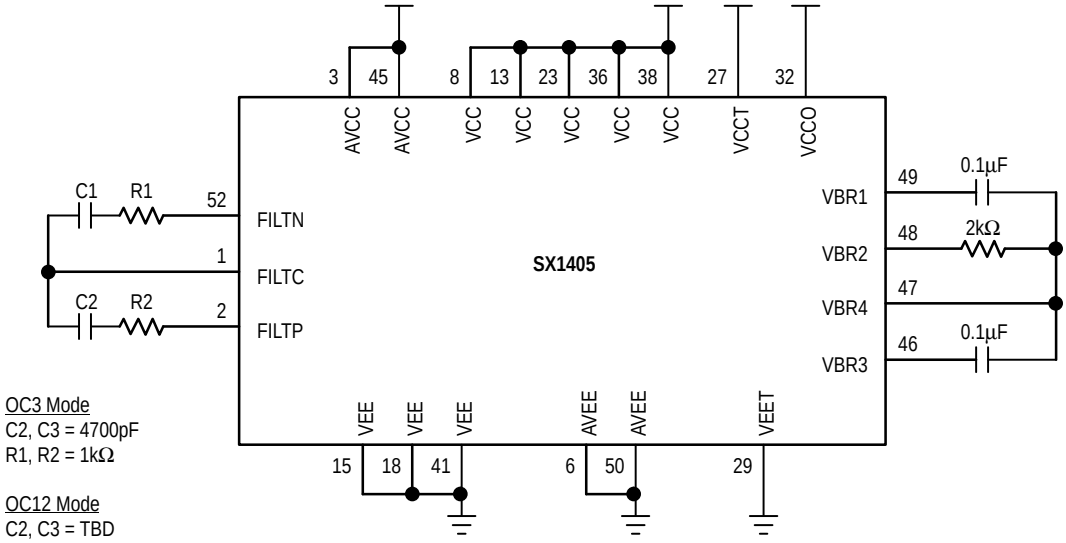


Figure 3. SX1405 Typical Operating Circuit

Table 1. SX1405 Pin Descriptions

Name	Pin No	Description
TTL Compatible I/O		
RETCK	14	Re–Time Latch Clock
DI8	16	Parallel Data Input (Byte LSB)
DI7	17	Parallel Data Input
DI6	19	Parallel Data Input
DI5	20	Parallel Data Input
DI4	21	Parallel Data Input (Nibble LSB)
DI3	22	Parallel Data Input
DI2	24	Parallel Data Input
DI1	25	Parallel Data Input (Byte and Nibble MSB)
OOL	26	Out of Lock Indicator Output
EPI	28	Even Parity Input
PLLCK	33	PLL Clock Out (19.44 / 38.88 / 77.76MHz)
RSTN	37	Reset Input
LSS	39	Low Speed Select Input
NBB	40	Nibble / Byte Select Input
ECSN	43	External Clock Select Input
PERR	44	Parity Error Output and Reset, Open Collector
PECL Compatible I/O		
VBB	7	PECL Voltage Reference Output (3.7V Nominally)
REFCKM	9	Differential Input Reference Clock Minus
REFCK	10	Differential Input Reference Clock Plus
VARCK	11	Differential Input Variable Clock Plus
VARCKM	12	Differential Input Variable Clock Minus
SOP	30	Differential Serial Data Output Plus
SOM	31	Differential Serial Data Output Minus
PLLCKM	34	PLL Clock Out (19.44 / 38.88 / 77.76MHz) Minus
PLLCKP	35	PLL Clock Out (19.44 / 38.88 / 77.76MHz) Plus
ECK	42	External Clock Input
Analog I/O		
FCM	5	VCO Frequency Control Monitor
VBR4–VBR1	46–49	VCO FIlter Pins
FILTN	52	Loop Filter Negative
FILTC	1	Loop Filter Common
FILTP	2	Loop Filter Positive
Power and Ground Pins		
AVCC	3, 45	Analog +5V Supply
AVEE	6, 50	Analog 0V Supply
VCC	8, 13, 23, 36, 38	PECL +5V Supply
VEE	15, 18, 41	PECL 0V Supply
VCCT	27	Output TTL +5V Supply
VEET	29	Output TTL 0V Supply
VCCO	32	Output PECL +5V Supply
Reserved		
N/C	4, 51	No Connection

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
VCC, VCCO, VCCT, AVCC	Power Supply (VEE, VEET, AVEE, GVEE = 0V)	–0.5 to +6.5	V
VIN	Input Voltage (VEE, VEET, AVEE, GVEE = 0V)	–0.5 to +6.5	V
IOUT	PECL Output Current Continuous Surge	50 100	mA
IOUT–TTL	TTL Output Current	TBD	mA
TSTG	Storage Temperature	–50 to +175	°C

* Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
VCC, VCCO, VCCT, AVCC	Power Supply (VEE, VEET, AVEE, GVEE = 0V)	5V ±5%	V
ICC	Device Current Drain	TBD	V
TA	Operating Temperature	–40 to +85	°C
TJ	Junction Temperature	125	°C

TTL DC CHARACTERISTICS (VCC = VCCT = VCCO = AVCC = 5.0V ±5%)

Symbol	Characteristic	Min	Typ	Max	Unit	Condition
IIH	Input HIGH Current			TBD	mA	VIN = 2.7V
IIL	Input LOW Current			–0.6	mA	VIN = 0.5V
VOH	Output HIGH Voltage	2.5			V	IOH = –2mA
VOL	Output LOW Voltage			0.5	V	IOL = 5mA
VIH	Input HIGH Voltage	2.0			V	
VIL	Input LOW Voltage			0.8	V	
IOZ	Tri–State Current			±15	µA	

100E PECL DC CHARACTERISTICS (VCC = VCCT = VCCO = AVCC = 5.0V ±5%)

Symbol	Characteristic	Min	Typ	Max	Unit	Condition
IIH	Input HIGH Current			200	mA	
IIL	Input LOW Current	0.5			mA	
VOH	Output HIGH Voltage	3.98		4.12	V	NOTE 1.
VOL	Output LOW Voltage	3.19		3.38	V	NOTE 1.
VIH	Input HIGH Voltage	3.83		4.12	V	NOTE 1.
VIL	Input LOW Voltage	3.19		3.53	V	NOTE 1.

1. PECL levels are referenced to VCC and will vary 1:1 with the Power Supply. The Outputs are loaded with an equivalent 50Ω termination to +3.0V. The values shown are for VCC = VCCT = VCCO = AVCC = 5.0V.

ANALOG DC CHARACTERISTICS (VCC = VCCT = VCCO = AVCC = 5.0V ±5%)

Symbol	Characteristic	Min	Typ	Max	Unit	Condition
VO	FCM Output with PLL Locked	0.75	1.25	1.75	V	
VO	FCM Output	0		2.50	V	
RO	FCM Output Impedance		5000		Ω	

2. VI is the minimum differential input voltage across the serial inputs RISP, RISN required to assure proper operation.

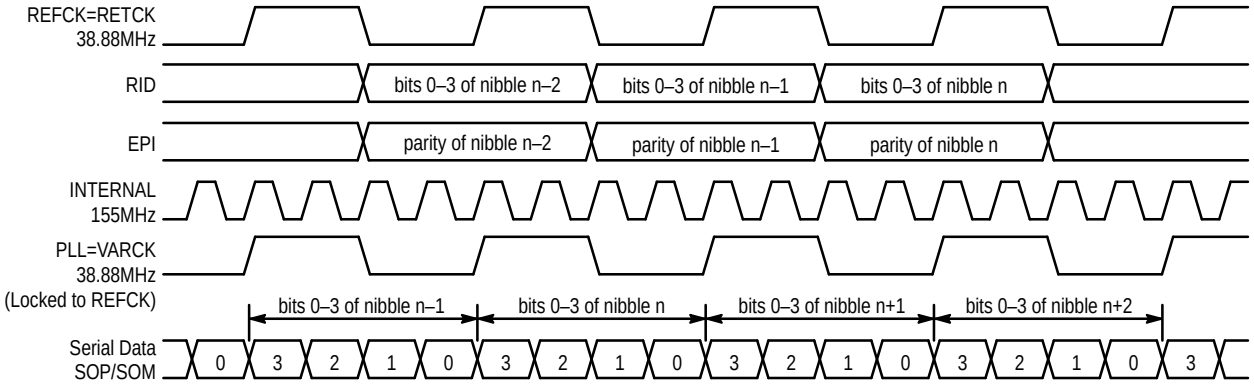


Figure 4. SX1405 Timing Diagram — OC–3, 4 Bits

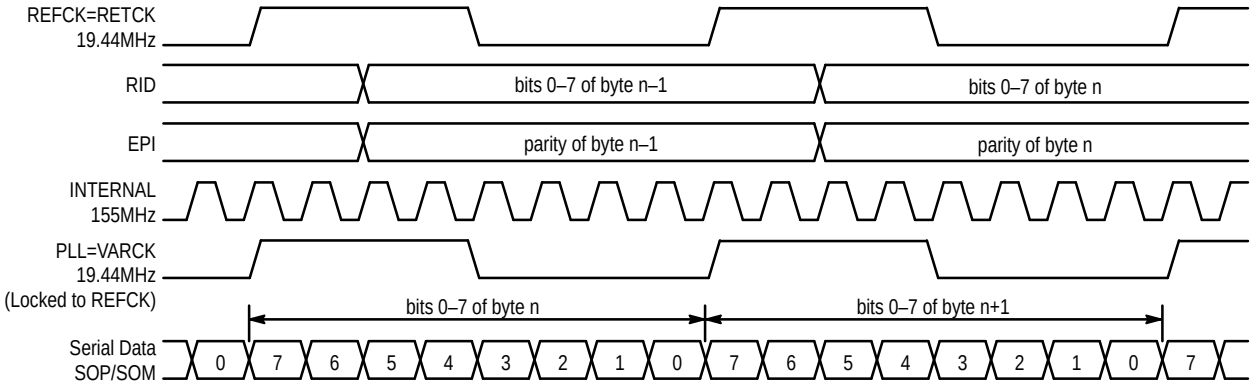


Figure 5. SX1405 Timing Diagram — OC–3, 8 Bits

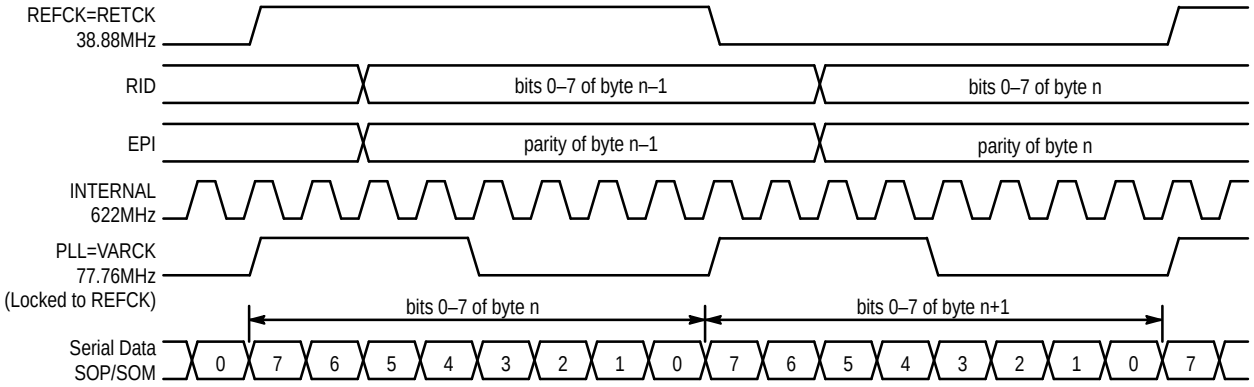


Figure 6. SX1405 Timing Diagram — OC–12, 8 Bits

AC CHARACTERISTICS (VCC = VCCT = VCCO = AVCC = 5.0V ±5%)

Symbol	Characteristic	–40°C		0°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
tr, tf	PECL Rise/Fall Time		1.0		1.0		1.0	nS	10–90%
tr, tf	TTL Rise/Fall Time		1.5		1.5		1.5	nS	10–90%, 470Ω, 15pF
ts	Set–Up Time DI, EPI → RETCK		100		100		100	pS	
th	Hold Time DI, EPI → RETCK		100		100		100	pS	
tskew	RETCK → PLLCK	–1.0	–4.0	–1.0	–4.0	–1.0	–4.0	nS	
tskew	REFCK → VARCK, 19MHz	–4.0	4.0	–4.0	4.0	–4.0	4.0	nS	
tskew	REFCK → VARCK, 38MHz	–2.0	2.0	–2.0	2.0	–2.0	2.0	nS	
tskew	REFCK → VARCK, 78MHz	–1.0	1.0	–1.0	1.0	–1.0	1.0	nS	
Fmax	Operating Frequency: PLLCK							MHz	

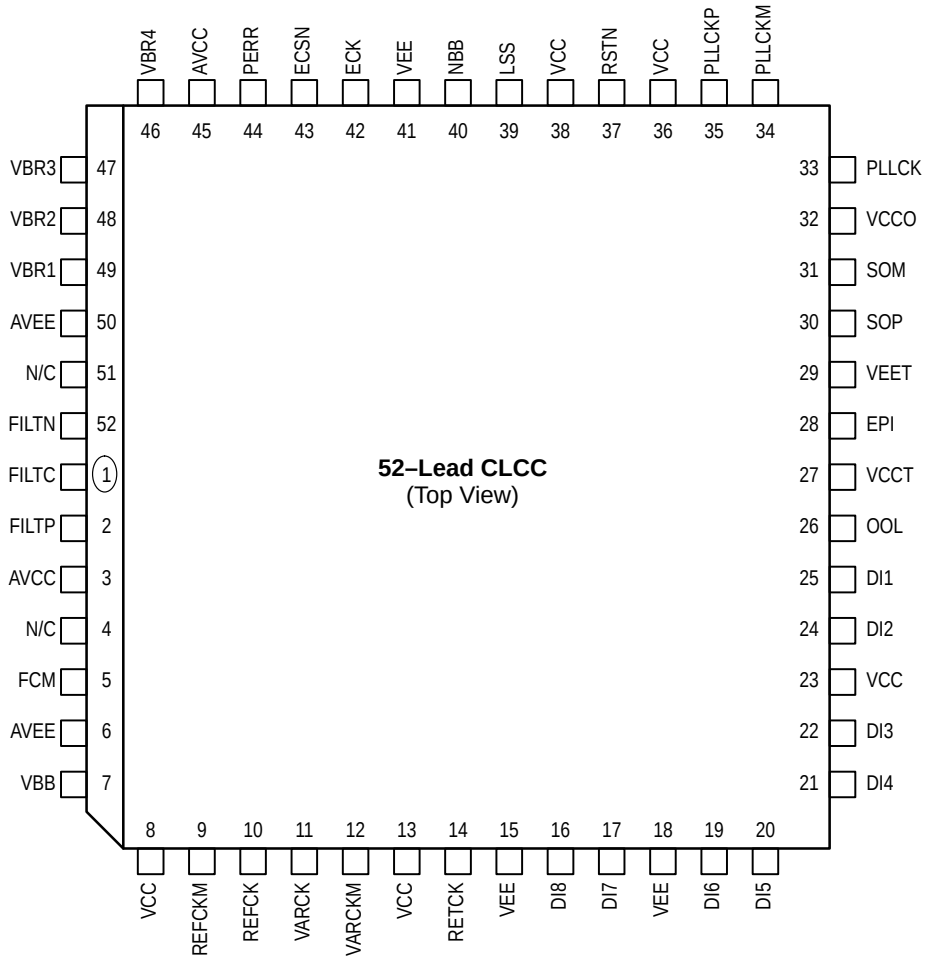
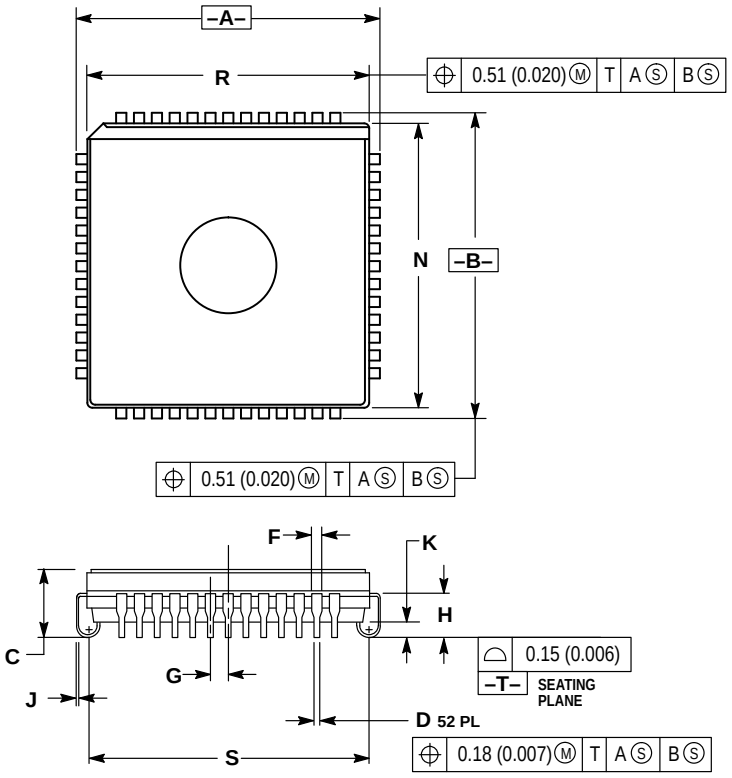


Figure 7. MC10SX1405 Pinout

OUTLINE DIMENSIONS

FN SUFFIX
PLASTIC CLCC PACKAGE
CASE 778B–01
ISSUE O



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION R AND N DO NOT INCLUDE GLASS PROTRUSION. GLASS PROTRUSION TO BE 0.25 (0.010) MAXIMUM.
4. ALL DIMENSIONS AND TOLERANCES INCLUDE LEAD TRIM OFFSET AND LEAD FINISH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.785	0.795	19.94	20.19
B	0.785	0.795	19.94	20.19
C	0.165	0.200	4.20	5.08
D	0.017	0.021	0.44	0.53
F	0.026	0.032	0.67	0.81
G	0.050 BSC		1.27 BSC	
H	0.090	0.130	2.29	3.30
J	0.006	0.010	0.16	0.25
K	0.035	0.045	0.89	1.14
N	0.735	0.756	18.67	19.20
R	0.735	0.756	18.67	19.20
S	0.690	0.730	17.53	18.54

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